

# **Applications**

- Edge QAM gain stage
- MDU Output
- Distribution amplifiers
- Node Transimpedance Amplifier

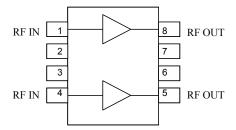


SOIC-8 package

#### **Product Features**

- 75  $\Omega$ , 50 MHz to 1200 MHz Bandwidth
- Low Noise Figure: 3.2 dB to 1000 MHz
- Adjustable Low Power Consumption
- pHEMT device technology
- SOIC-8 package

## **Functional Block Diagram**



## **General Description**

The TAT7469 is a 75  $\Omega$  RF Amplifier designed for CATV use, but capable of operation up to 1200 MHz. The TAT7469 contains two separate amplifiers for push pull applications. It is fabricated using 6-inch GaAs pHEMT technology to optimize performance and cost. Each amplifier contains on-chip active biasing. The bias current set point of each amplifier is adjustable with a single resistor from the input to ground.

## **Pin Configuration**

IN A
Internal Connect
IN B
OUT B
OUT A
√D

## **Ordering Information**

Part No.	Description
TAT7469	75 Ω Dual pHEMT Amplifier (lead-free/RoHS compliant SOIC-8 Pkg)
TAT7469-SC8-EB	Evaluation Board

Standard T/R size = 1000 pieces on a 7" reel.

Data Sheet: Rev D 6/13/11

© 2011 TriQuint Semiconductor, Inc.

- 1 of 8 -

Disclaimer: Subject to change without notice

Connecting the Digital World to the Global Network®



## **Specifications**

## **Absolute Maximum Ratings**

Parameter	Rating
Device Voltage	+10.0 V
Operating Temperature	-40 to 85 °C

Operation of this device outside the parameter ranges given above may cause permanent damage.

## **Recommended Operating Conditions**

Parameter	Min	Тур	Max	Units
$ m V_{DD}$		5		V
$I_{\mathrm{DD}}$		250		mA
$T_{\rm J}$ (for $> 10^6$ hours MTTF)			145	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions

## **Electrical Specifications**

Test conditions unless otherwise noted: 25 °C Case Temperature. +5 V V<sub>DD</sub>

Parameter	Conditions	Min	Typical	Max	Units
Operational Frequency Range		50		1002	MHz
Gain			17.5		dB
Gain Flatness	Note 1		±0.75		dB
Noise Figure			3.2		dB
Input Return Loss	To 1000 MHz		18		dB
Output Return Loss	To 1000 MHz		23		dB
Output IP3	Note 2		38		dBm
Output IP2	Note 2, Note 3		68		dBm
$I_{DD}$	5V, Note 4		250		mA
Thermal Resistance (jnt to case) $\theta_{ic}$	Note 5		16.5		°C/W

#### Notes:

- 1. Flatness determined by deviation from a straight-line curve fit
- 2. 10 dBm/tone output, applied tones at 225 MHz and 325 MHz
- 3. Calculated from difference intermod
- 4. R3 and R4 are used to set the bias current,  $10\;k\Omega$
- 5. Refer to Thermal Analysis Report.

Data Sheet: Rev D 6/13/11

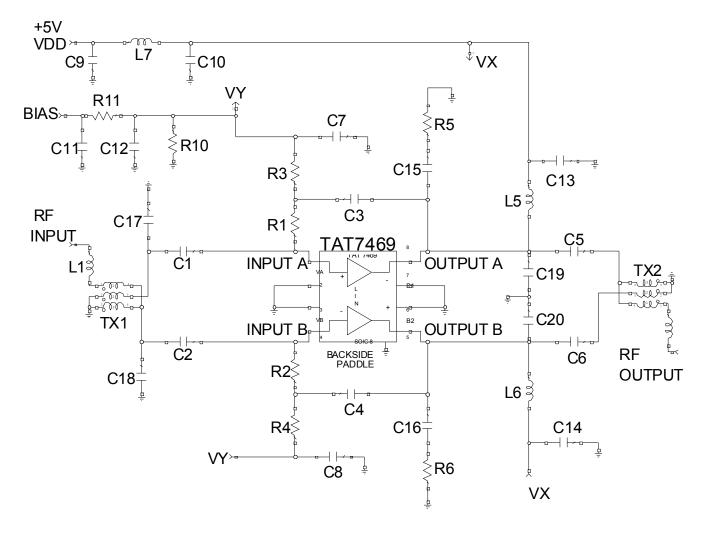
- 2 of 8 -Disclaimer: Subject to change without notice

Connecting the Digital World to the Global Network®





# **Application Circuit Reference Design 50-1002 MHz**

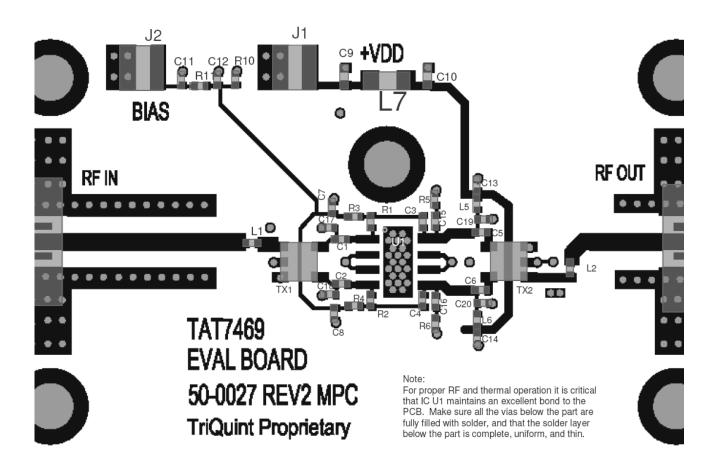


Notes:

1. See PC Board Layout, page 4 for more information.



# **PC Board Layout**





# **Application Circuit BOM 50-1002 MHz**

### **Bill of Material**

Ref. Desg.	Value	Description <sup>(1)</sup>	Manufacturer	Part Number
U1		75 Ω Dual pHEMT Amplifier	TriQuint	TAT7469
L1	3.6 nH	Chip Coil, 0402, 5 %	CoilCraft	0402CS-3N6XJLW
L2	2.2 nH	Chip Coil, 0402, 5 %	CoilCraft	0402CS-2N2XJLW
L5, L6	560 nH	Chip Coil, 0402, 5 %	CoilCraft	0402AF-561XJLW
L7	0.9 uH	Chip Coil, 1008, 10%	various	
TX1, TX2	1:1	1:1 Balun, 5 – 3000 MHz	MiniCircuits	TC1-33-75G2+
C1, C2, C3, C4, C7, C8, C11, C12, C13, C14	0.01 uF	Ceramic Cap, 0402, 16 V, NPO, 10 %	various	
C5, C6	470 pF	Ceramic Cap, 0402, 50 V, NPO, 10 %	various	
C15, C16	1.0 pF	Ceramic Cap, 0402, 50 V, ±0.10 pF	AVX	04025A010BAT9A
C17, C18	0.5 pF	Ceramic Cap, 0402, 50 V, ±0.10 pF	AVX	04025A005BAT9A
C9, C10	0.1 uF	Ceramic Cap, 0603, 16 V, NPO, 10 %	various	
R1, R2	820 Ω	Thick Film Res, 0402, 1 %	various	
R3, R4	10 kΩ	Thick Film Res, 0402, 1 %	various	
R5, R6	30 Ω	Thick Film Res, 0402, 1 %	various	
R10	100 Ω	Thick Film Res, 0402, 1 %	various	
R11	0 Ω	Thick Film Res, 0402	various	
C19, C20	N/L	Do Not Place Parts		
J3, J4	F-Edge Mount	75 Ω Female connector	Amphenol	531-40039

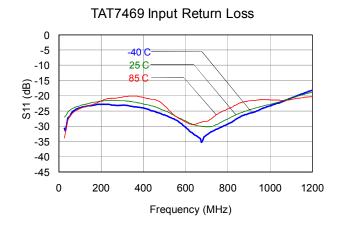
Notes:

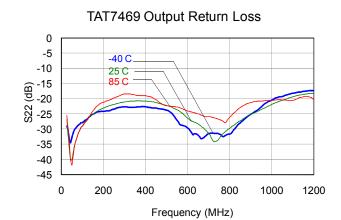
1. Or equivalent

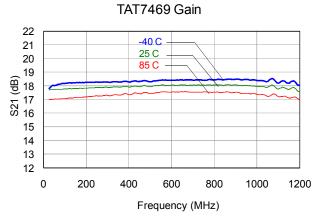


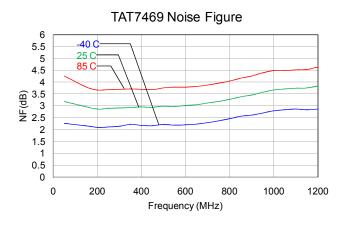
# **Application Board Typical Performance**

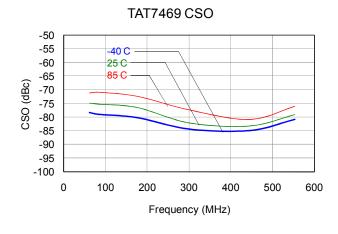
 $V_{DD}$  = +5 V,  $I_{DD}$  = 235 mA (at 25 °C), Temperatures are case temp

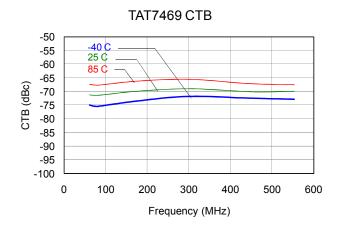












#### Notes

1. CSO and CTB: 39 dBmV/ch at output, 80 ch NTSC flat

Data Sheet: Rev D 6/13/11 © 2011 TriQuint Semiconductor, Inc. - 6 of 8 -

Disclaimer: Subject to change without notice Connecting the Digital World to the Global Network®

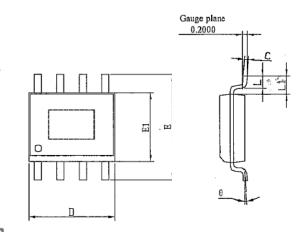


# **Mechanical Information**

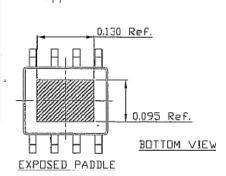
## **Package Information and Dimensions**

This package is lead-free/RoHS-compliant. The plating material on the leads is 100% Matte Tin. It is compatible with both lead-free (maximum 260 °C reflow temperature) and lead (maximum 245 °C reflow temperature) soldering processes.

The TAT7469 will be marked with a "TAT7469" designator and an 8 digit alphanumeric lot code (XXXXYYWW). The first four digits are the lot code (XXXX). The last four digits are a date code consisting of the year and work week (YYWW) of assembly.



SYMBOLS	DIMENSIONS IN MILLIMETERS			DIMENSIONS IN INCHES		
STABOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	1,40	1.50	1,60	0.055	0.059	0.063
A1	0.00		0.10	0.000		0.004
A2		1.45			0.057	
В	0,33		0.51	0,013		0,020
C	0.19		0.25	0.007		0.010
D	4,80		5,00	0.189		0.197
E1	3.80	3.90	4.00	0.150	0.153	0.157
e		1.27			0.050	
E	5,80	6.00	6.20	0.228	0.236	0.244
L	0.40		1.27	0.016		0.050
У			0.10			0.004
θ	0°		8°	0°		8°
L1-L1'			0.12			0.005
Ll	1.04REF			0.041REF		



7,0000° (4X)

Data Sheet: Rev D 6/13/11 © 2011 TriQuint Semiconductor, Inc. - 7 of 8 - Disclaimer: Subject to change without notice

# **TAT7469**

## CATV 75 $\Omega$ pHEMT Dual RF Amplifier



## **Product Compliance Information**

#### **ESD Information**



## Caution! ESD-Sensitive Device

ESD Rating: Class 1 B

Value: Passes ≥ 600 V min.

Test: Human Body Model (HBM)

Standard: JEDEC Standard JESD22-A114

ESD Rating: Class IV+

Value: Passes  $\geq 2000 \text{ V min.}$ 

Test: Charged Device Model (CDM) Standard: JEDEC Standard JESD22-C101

## **MSL Rating**

Level 3 at +260 °C convection reflow. The part is rated Moisture Sensitivity Level 3 at 260 °C per JEDEC standard IPC/JEDEC J-STD-020.

## **Solderability**

Compatible with the latest version of J-STD-020, Lead free solder, 260 °C.

is part is compliant with EU 2002/95/EC RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment).

### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations, and information about TriQuint:

Web: <u>www.triquint.com</u> Tel: +1.707.526.4498 Email: <u>info-sales@tgs.com</u> Fax: +1.707.526.1485

For technical questions and application information:

Email: sjcapplication.engineering@tgs.com

# **Important Notice**

The information contained herein is believed to be reliable. TriQuint makes no warranties regarding the information contained herein. TriQuint assumes no responsibility or liability whatsoever for any of the information contained herein. TriQuint assumes no responsibility or liability whatsoever for the use of the information contained herein. The information contained herein is provided "AS IS, WHERE IS" and with all faults, and the entire risk associated with such information is entirely with the user. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for TriQuint products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information.

TriQuint products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.

Data Sheet: Rev D 6/13/11
© 2011 TriQuint Semiconductor, Inc.

- 8 of 8 - Disclaimer: Subject to change without notice

Connecting the Digital World to the Global Network®